



AF/1742
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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR(S) : Hwang, Jennie S.
TITLE : High Temperature Lead-Free Solders
APPLICATION NO. : 10/056,667
FILED : October 29, 2001
CONFIRMATION NO. : 1009
EXAMINER : Ip, Sikyin
ART UNIT : 1742
LAST OFFICE ACTION : March 23, 2004
ATTORNEY DOCKET NO. : RJMZ 200062
Cleveland, OH 44114
June 22, 2004

RESPONSE

MAIL STOP
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Office Action mailed March 23, 2004, in the above-referenced patent application.

A new continuation-in-part (CIP) application is being filed concurrently herewith.

CERTIFICATE OF MAILING

I certify that this Information Disclosure Statement and accompanying document(s) are being
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